

#### HIGH VOLTAGE POWER SCHOTTKY RECTIFIER

### **Product Summary**

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F (MAX)</sub> (V) @ +25°C	I <sub>R (MAX)</sub> (mA) @ +25°C
60	2x10	0.85	0.15

## **Description**

High voltage dual Schottky rectifier suited for switch mode power supplies and other power converters. This device is intended for use in medium voltage operation, and particularly, in high frequency circuits where low switching losses and low noise are required.

The MBR2060C is available in TO-220-3 (2) and TO-220F-3 packages.

# **Applications**

- Power Supply Output Rectification
- **Power Management**
- Instrumentation



TO-220F-3

#### **Features**

- Low Forward Voltage: 0.85V @ +25°C
- High Surge Current Capacity
- +150°C Operating Junction Temperature
- 20A Total (10A Each Diode Leg)
- **Guard-Ring for Stress Protection**
- TO-220F-3
  - Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Available in "Green" Packages: TO-220-3 (2), TO-220F-3
  - Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
  - Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: TO-220-3 (2), TO-220F-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Below
- Weight:
  - TO-220-3 (2) 1.95 Grams (Approximate)
  - TO-220F-3 1.69 Grams (Approximate)

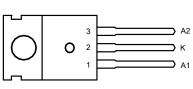


TO-220-3 (2)

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

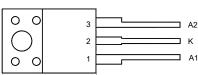
#### Pin Assignments



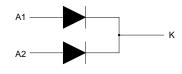
TO-220-3 (2)

(Front View)

0



(Front View)

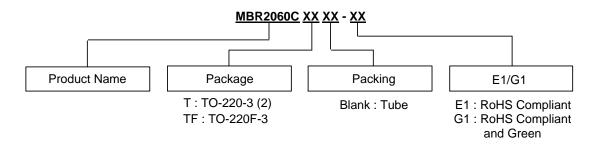


Internal Structure of MBR2060C

TO-220F-3



# **Ordering Information**



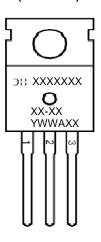


Package	Part Number	Marking ID	Packing
TO-220-3 (2)	MBR2060CT-G1	MBR2060CT-G1	50 Pieces/Tube
TO-220F-3	MBR2060CTF-E1	MBR2060CTF-E1	50 Pieces/Tube
TO-220F-3	MBR2060CTF-G1	MBR2060CTF-G1	50 Pieces/Tube

# **Marking Information**

### (1) TO-220-3 (2)





First and Second Lines: Logo and Marking ID (See Ordering Information)

Third Line: Date Code

Y: Year

WW: Work Week of Molding A: Assembly House Code

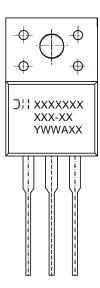
XX: 7th and 8th Digits of Batch Number



### Marking Information (Cont.)

#### (2) TO-220F-3

#### (Front View)



First and Second Lines: Logo and Marking ID (See Ordering Information)
Third Line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code

XX: 7th and 8th Digits of Batch Number

# Maximum Ratings (Each Diode Leg) (Note 4)

Characteristic	Symbol	Rating	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (Rated $V_R$ ) $T_C = +136$ °C	I <sub>F(AV)</sub>	10	А
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20kHz) T <sub>C</sub> = +131°C	I <sub>FRM</sub>	20	А
Non Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Half Wave, Single Phase, 60Hz)	I <sub>FSM</sub>	150	А
Operating Junction Temperature (Note 5)	TJ	+150	°C
Storage Temperature Range	T <sub>STG</sub>	-50 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10000	V/µs
ESD (Machine Model = C)	_	>400	V
ESD (Human Body Model = 3B)	_	>8000	V

Notes: 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

5. The heat generated must be less than the thermal conductivity from Junction to Ambient:  $dP_D/dT_J < 1/\theta_{JA}.$ 



# **Thermal Characteristics**

Characteristic	Symbol	Rating		Unit
Maximum Thermal Resistance (Junction to Case)	R <sub>eJC</sub>	TO-220-3 (2)	2.5	°C/W
(Note 6)		TO-220F-3	4.5	
Maximum Thermal Resistance (Junction to Ambient)	R <sub>0JA</sub>	TO-220-3 (2)	60	
(Note 6)		TO-220F-3	60	

Note 6: Device mounted on heat sink, with minimum recommended pad layout per http://www.diodes.com/package-outlines.html.

# Electrical Characteristics (Each Diode Leg)

Characteristic	Symbol	Rating	Unit	Test Condition
Maximum Instantaneous Forward Voltage Drop (Note 7)	V <sub>F</sub>	0.85	V	I <sub>F</sub> = 10A, T <sub>C</sub> = +25°C
		0.75		I <sub>F</sub> = 10A, T <sub>C</sub> = +125°C
		0.15	mA	Rated DC Voltage, T <sub>C</sub> = +25°C
Maximum Instantaneous Reverse Current (Note 7)	IR	15		Rated DC Voltage, T <sub>C</sub> = +125°C

Note 7: Short duration pulse test used to minimize self-heating effect, Pulse Test Width = 300µs, Duty Cycle < 2.0%.

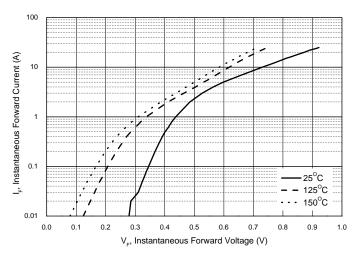


Figure 1. Typical Forward Voltage

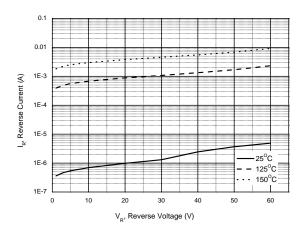


Figure 2. Typical Reverse Current

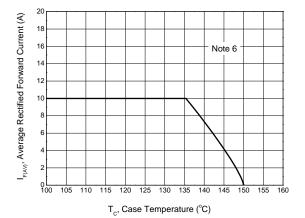


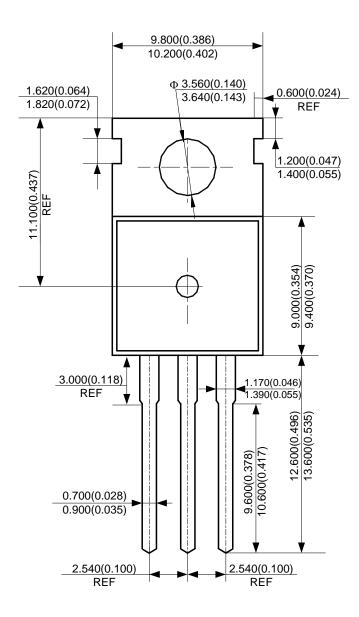
Figure 3. Average Rectified Forward Current vs.

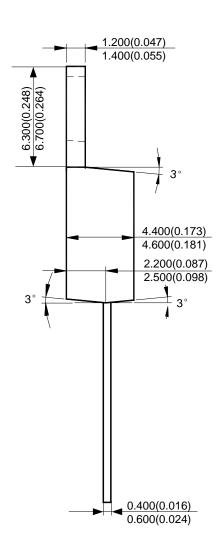
Case Temperature (Per Diode)



# Package Outline Dimensions (All dimensions in mm(inch).)

#### (1) Package Type: TO-220-3 (2)

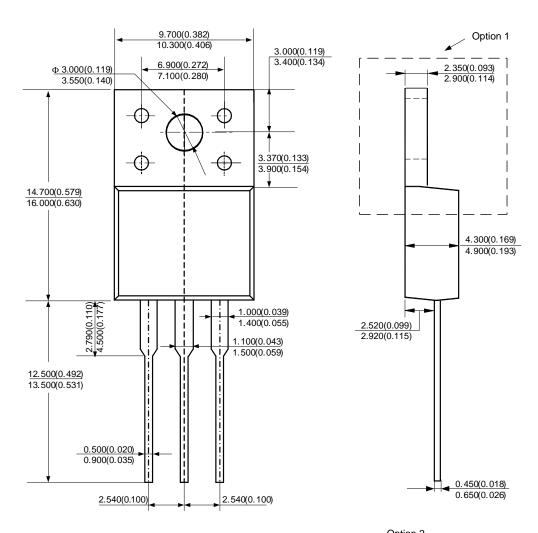






# Package Outline Dimensions (Cont. All dimensions in mm(inch).)

#### (2) Package Type: TO-220F-3



Option 2

3.190(0.126)
3.250(0.128)
5°
5°



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